



MMBT2222A

40V NPN SMALL SIGNAL TRANSISTOR IN SOT23

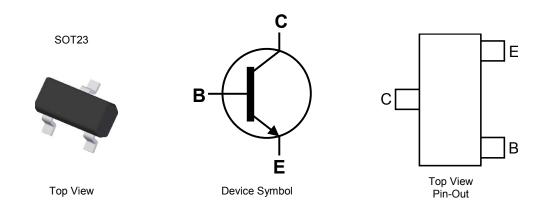
Features

- Epitaxial Planar Die Construction
- Low Saturation Voltage V_{CE(sat)} < 300mV @ 150mA
- Complementary PNP Type: MMBT2907A
- Ideal for Low Power Amplification and Switching
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- The MMBT2222AQ-7-F is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/guality/product-definitions/

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish; Solderable per MIL-STD-202, Method 208 3
- Weight: 0.008 grams (Approximate)



Ordering Information (Note 4)

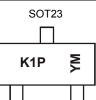
Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
MMBT2222A-7-F	Standard	K1P	7	8	3,000
MMBT2222A-13-F	Standard	K1P	13	8	10,000
MMBT2222AQ-7-F	Automotive	K1P	7	8	3,000

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



K1P = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: H = 2020) M or \overline{M} = Month (ex: 9 = September)

Date Code Key						-						
Year	202	0 2	021	2022	2023	2024	2025	202	6 2	027	2028	2029
Code	Н			J	K	L	М	N		0	Р	R
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



Absolute Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	75	V
Collector-Emitter Voltage	V _{CEO}	40	V
Emitter-Base Voltage	V _{EBO}	6.0	V
Collector Current	lc	600	mA
Peak Pulse Collector Current (single pulse)	ГСМ	800	mA
Peak Pulse Base Current	I _{BM}	200	mA

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Collector Rower Dissipation	(Note 5)	D-	310	mW	
Collector Power Dissipation	(Note 6)	P _D	350		
Thermal Resistance, Junction to Ambient	(Note 5)	P	403	°C/W	
Thermal Resistance, Junction to Ambient	(Note 6)	R _{θJA}	357	C/W	
Thermal Resistance, Junction to Leads (Note 7)		$R_{\theta JL}$	350	°C/W	
Operating and Storage Temperature Range	T _J ,T _{STG}	-55 to +150	°C		

ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes: 5. For a device mounted on minimum recommended pad layout 1oz copper that is on a single-sided FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state.

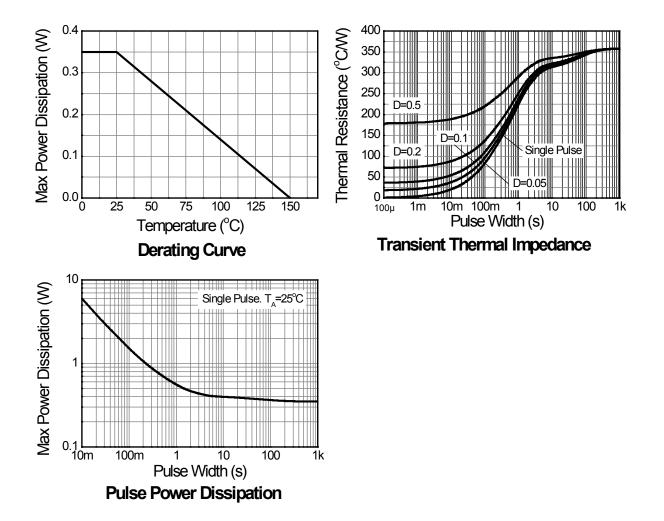
6. Same as Note 5, except the device is mounted on 15 mm x 15mm 1oz copper.

7. Thermal resistance from junction to solder-point (at the end of the leads).

8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS					1
Collector-Base Breakdown Voltage	BV _{CBO}	75		V	I _C = 100μA, I _E = 0
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	40	_	V	I _C = 10mA, I _B = 0
Emitter-Base Breakdown Voltage	BV _{EBO}	6.0		V	I _E = 100μA, I _C = 0
Collector Cut-Off Current	I _{CBO}	_	10	nA μA	$V_{CB} = 60V, I_E = 0$ $V_{CB} = 60V, I_E = 0, T_A = +150^{\circ}C$
Collector Cut-Off Current	I _{CEX}	_	10	nA	$V_{CE} = 60V, V_{EB(off)} = 3.0V$
Collector Cut-Off Current	ICEV		10	nA	V _{CE} = 60V, V _{BE} = ±0.25V
Emitter Cut-Off Current	I _{EBO}		10	nA	$V_{EB} = 5.0V, I_{C} = 0$
Base Cut-Off Current	I _{BL}		20	nA	V _{CE} = 60V, V _{EB(off)} = 3.0V
ON CHARACTERISTICS (Note 9)		•			.
DC Current Gain	h _{FE}	35 50 75 100 40 50 35	 300 	_	$\begin{split} I_{C} &= 100 \mu A, \ V_{CE} &= 10V \\ I_{C} &= 1.0 m A, \ V_{CE} &= 10V \\ I_{C} &= 10 m A, \ V_{CE} &= 10V \\ I_{C} &= 150 m A, \ V_{CE} &= 10V \\ I_{C} &= 500 m A, \ V_{CE} &= 10V \\ I_{C} &= 10 m A, \ V_{CE} &= 10V, \ T_{A} &= -55^{\circ}C \\ I_{C} &= 150 m A, \ V_{CE} &= 1.0V \end{split}$
Collector-Emitter Saturation Voltage	V _{CE(sat)}	_	0.3 1.0	V	I_{C} = 150mA, I_{B} = 15mA I_{C} = 500mA, I_{B} = 50mA
Base-Emitter Saturation Voltage	V _{BE(sat)}	0.6	1.2 2.0	V	I_{C} = 150mA, I_{B} = 15mA I_{C} = 500mA, I_{B} = 50mA
SMALL SIGNAL CHARACTERISTICS		•			·
Output Capacitance	C _{obo}	_	8	pF	V _{CB} = 10V, f = 1.0MHz, I _E = 0
Input Capacitance	Cibo	_	25	pF	V _{EB} = 0.5V, f = 1.0MHz, I _C = 0
Transition frequency	f _T	300	_	MHz	V _{CE} = 20V, I _C = 20mA, f = 100MHz
Noise Figure	N _F	—	4.0	dB	V_{CE} = 10V, I _C = 100µA, R _S = 1.0kΩ, f = 1.0kHz
SWITCHING CHARACTERISTICS		•			·
Delay Time	t _d	_	10	ns	$\label{eq:VCC} \begin{array}{l} V_{CC} = 30V, \ I_C = 150mA, \\ V_{BE(off)} = -0.5V, \ I_{B1} = 15mA \end{array}$
Rise Time	tr		25	ns	V_{CC} = 30V, I _C = 150mA, I _{B1} = 15mA, V _{BE(off)} = 0.5V
Storage Time	ts	_	225	ns	$V_{CC} = 30V, I_C = 150mA,$ $I_{B1} = -I_{B2} = 15mA$
Fall Time	t _f		60	ns	V _{CC} = 30V, I _C = 150mA, I _{B1} = -I _{B2} = 15mA

Note: 9. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.





T_A = -50°C

f = 1MHz

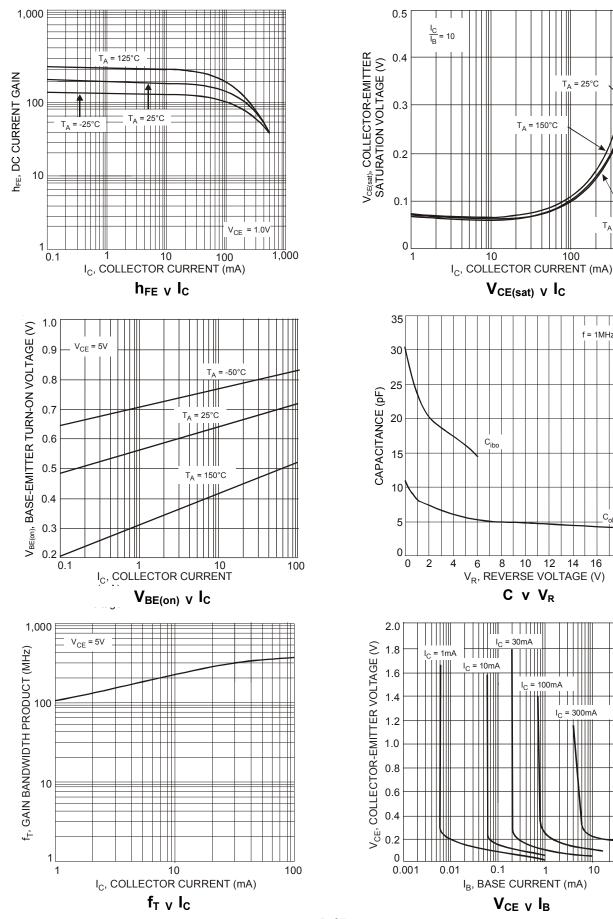
C_{obo}

I_C = 300mA

18 20

1,000

TA = 25°C



10

1

MMBT2222A Document number: DS30041 Rev. 17 - 2

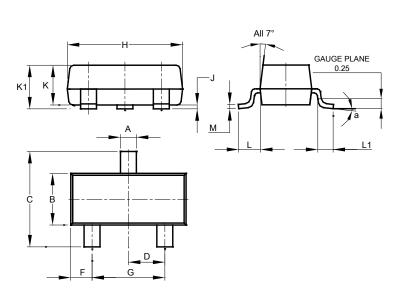
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Package Outline Dimensions

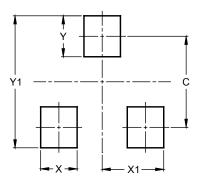
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23								
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
С	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
н	2.80	3.00	2.90					
J	0.013	0.10	0.05					
ĸ	0.890	1.00	0.975					
K1	0.903	1.10	1.025					
L	0.45	0.61	0.55					
L1	0.25	0.55	0.40					
М	0.085	0.150	0.110					
а	0°	8°						
All	All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



 Dimensions
 Value (in mm)

 C
 2.0

 X
 0.8

 X1
 1.35

 Y
 0.9

2.9

Y1

SOT23

SOT23



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